

## **C1210X123FATACTU**

Aliases (C1210X123FATAC7800) SMD Comm X8G HT150C Flex, Ceramic, 0.012 uF, 1%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



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General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	30 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		Specific
Chip Size	1210	Capacit
L	3.3mm +/-0.4mm	Measure
W	2.6mm +/-0.3mm	Tolerand
Т	0.78mm +/-0.20mm	Voltage
S	1.5mm MIN	Dielectr
В	0.6mm +/-0.25mm	Temper
		Temp. C

## **Packaging Specifications**

Packaging Quantity 4000	Packaging	T&R, 180mm, Plastic Tape
	Packaging Quantity	4000

Specifications	
Capacitance	0.012 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	1%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	83.3333 GOhms

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